

LCD Driver ROM：2，4， 6 ，or $8 \mathrm{~K} \times 16$ bits，RAM： $512 \times 4$ bits

Preliminary

## Overview

The LC587202A through LC587208A are 4－bit CMOS microcontrollers that integrate ROM，RAM，and an extensive set of peripheral functions around a CPU core that supports low－voltage operation．Memory capacities include $2,4,6$ ，or 8 K of 16 －bit ROM， $512 \times 4$ bits of RAM，and a special－purpose RAM for the 8 －level stack． Peripheral functions include two 8－bit timers（one of which can be used as an event counter），an 8 －bit synchronous serial interface，an alarm signal generator，a remote controller carrier signal generator，and an LCD controller／driver circuit．These microcontrollers provide a powerful set of standby functions for reduced power dissipation．

## Applications

－Portable electronic equipment that uses an LCD display （These microcontrollers are particularly well－suited for portable equipment that requires low－power operation for extended battery life．）
－Control and LCD display in portable CD players，timers， and consumer health maintenance equipment
－Remote controls for CD players，VCRs，and tuners

## Features

ROM
－LC587208A（ $8192 \times 16$ bits）
－LC587206A（ $6144 \times 16$ bits）
－LC587204A（ $4096 \times 16$ bits）
－LC587202A（ $2048 \times 16$ bits）

RAM
－LC587208A（ $512 \times 4$ bits）
－LC587206A（ $512 \times 4$ bits）
－LC587204A（ $512 \times 4$ bits）
－LC587202A（512 $\times 4$ bits）

## Package Dimensions

Unit：mm
3159－QFP64E

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## Instruction cycle times

Except for the table reference instruction，all instructions execute in a single cycle．

| Cycle time | Supply voltage | System clock oscillator | Oscillator frequency |
| ---: | :---: | :---: | :---: |
| 667 ns | 4.5 to 6.0 V | CF（ceramic）oscillator | 6 MHz |
| $1 \mu \mathrm{~s}$ | 2.8 to 6.0 V | CF（ceramic）oscillator | 4 MHz |
| $4 \mu \mathrm{~s}$ | 2.5 to 6.0 V | CF（ceramic）oscillator | 1 MHz |
| $10 \mu \mathrm{~s}$ | 2.2 to 6.0 V | CF（ceramic）oscillator | 400 kHz |
| $122 \mu \mathrm{~s}$ | 2.0 to 6.0 V | Crystal oscillator | 32.768 kHz |

## Ports

Input－only pins
－Port S（4 pins）
－The INT pin（1 pin）
I／O Pins
－Port K（4 pins）
The output circuits are CMOS circuits，and cannot be modified．
－Port M（4 pins）
The output circuits are either CMOS or p－channel circuits，and the type can be selected under program control in single－port units．
（The M4 pin is set to its input pin function when timer 2 is used as an event counter．）
－Port SO（4 pins）
The output circuits are either CMOS or n－channel circuits，and the type can be selected under program control in single－port units．
The three pins SO1，SO2，and SO3 also function as the serial interface pins．（Two－pin serial interface operation is also supported．）
－Port P（4 pins）
The output circuits are either CMOS or p－channel circuits，and the type can be selected under program control in single－port units．
Output－only pins
－Port N（4 pins）
The N3 pin also functions as the remote controller carrier output pin，and the N 4 pin also functions as the alarm output pin．
LCD drive pins
－Common pins（4 pins）
－Segment pins（23 pins）
The segment pin circuits include built－in memory（called＂segment memory＂）that holds the output data．These pins can also be switched in single－pin units in the mask options to function as general－purpose outputs（CMOS，p－channel，or n－channel）．

## Wide selection of LCD drive techniques

| LCD drive technique | Number of segments that can be driven | Required common pins |
| :---: | :---: | :---: |
| $1 / 3$ bias $1 / 4$ duty | 92 segments | COM1 to COM4 |
| $1 / 3$ bias $1 / 3$ duty | 69 segments | COM1 to COM3 |
| $1 / 2$ bias $1 / 4$ duty | 92 segments | COM1 to COM4 |
| $1 / 2$ bias $1 / 3$ duty | 69 segments | COM1 to COM3 |
| Duplex | 46 segments | COM1，COM2 |
| Static | 23 segments | COM1 |

## LCD controller（Hardware functions that facilitate the development of display control software）

## Segment PLA（option）

This technique allows the LCD drivers（common 1 through common 4）to be controlled according to user software design，i．e．the relationship between LCD segment control strobe signals and the data．This technique is more difficult for the chip manufacturer，but it allows software design and the LCD panel layout design to be completely independent． Thus it supports highly efficient product development and is a major plus for the user．Furthermore，there is no need for a routine that converts data held in RAM to LCD driver output data．
Segment decoder
These microcontrollers provide a decoder for 7 －segment displays．This circuit also allows binary data to be output without modification for display control of flag areas that display various operating states．

## Strobe decoder

This function groups segments for easier program development and display control．

## Timers

Timer 1
－Six－bit prescaler +8 －bit programmable reload timer
（The prescaler is shared by timer 1，timer 2，and the serial interface．）
－Supports the generation of remote control carrier signals under program control．
Timer 2
－Six－bit prescaler +8 －bit programmable timer （The prescaler is shared by timer 1 ，timer 2，and the serial interface．）
－Can also be used as an event counter．
Base timer（When the 32.768 kHz crystal oscillator option is selected）
－Two frequencies from a set of four base frequencies（either 125 ms and 500 ms ，or 100 ms and 250 ms ）can be selected as a combination of mask option and program selection to flexibly support end products．

## Standby functions

Halt mode
－Instruction execution is stopped in this mode．The oscillator circuits，the timers，the LCD controller and driver circuits， and the serial interface continue to operate．This mode allows unnecessary loops to be avoided and therefore power dissipation can be reduced by the effective use of this mode．
－The halt mode clear（exit）conditions can be set by application programs．The following functions can be used to clear halt mode．
— Transitions on the INT pin signal（1 factor）
－Timer 1 （1 factor）
－Timer 2 （1 factor）
－Base timer（1 factor）
－Transitions on either the serial interface pins or the SO4 pin（One or the other of these two factors）
－Transitions on the S and K port signals as defined by the SSW instruction（8 factors）
－The reset signal
Hold mode
－This is a full standby mode in which the oscillator circuits are stopped．
－The hold mode clear（exit）conditions can be set by application programs．The following functions can be used to clear hold mode．
－Transitions on the INT pin signal（1 factor）
－Timer 2 in event counter mode（ 1 factor）
－Transitions on either the serial interface pins or the SO4 pin（One or the other of these two factors）
－Transitions on the S and K port signals as defined by the SSW instruction（8 factors）
－The reset signal

## Interrupt function（5 factors with 4 vector addresses）

－Transitions on the INT pin signal（1 factor）
－Timer 1 （1 factor）
－Timer 2 （1 factor）
－Transitions on either the serial interface pins or the SO4 pin（One or the other of these two factors）

## Watchdog timer

A 16－bit counter is used．This circuit supports reset based on a combination of two points the program passes through for flexible application support．This watchdog timer circuit supports the following operating times．
Crystal oscillator used（ 32.768 kHz ， 1 or 2 cycles）：Up to 2000 ms （max）
CF oscillator used（ $1 \mathrm{MHz}, 1$ cycle）：Up to 65.536 ms （max）

## Subroutine stack

These microcontrollers provide an 8－level stack in special－purpose RAM for subroutines and interrupt handling．Thus data RAM is not required for saving the program counter．

## Instruction set

These microcontrollers provide 126 easy－to－use instructions，including accumulator manipulation，register to／from memory transfer，arithmetic，logical operation，flag manipulation，and I／O port control instructions，as well as a full set of conditional branch instructions．

## Oscillator circuits（three types）

Single－oscillator specifications：One oscillator，either a CF，RC，or crystal oscillator．
Dual－oscillator specifications：Either a CF and a crystal oscillator，or an RC and a crystal oscillator．
CF（ceramic）oscillator circuit
－Used for the system clock in fast mode
－ 400 kHz to 6 MHz
RC（resistor／capacitor）oscillator circuit
－Used for the system clock in fast mode
－ 400 kHz to 800 kHz
－Two－terminal oscillator circuit
Crystal oscillator circuit
－Used for the system clock in slow mode
－ $32.768,38.2293$ ，or 65.536 kHz

## Package options

－QIP64E（flat package）
－Chip

## Pin Assignment


－Pin 35 （TST）must be connected to VSS during normal operation．
－Consult your Sanyo representative in advance before using solder bath or spray techniques for mounting

## Pad Arrangement

（Applies to the chip version of the product．）


Pad Coordinates（unit：$\mu \mathrm{m}$ ）
（Applies to the chip version of the product．）

| No． | Pad | X | Y | No． | Pad | X | Y |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | VDD | －1854 | －1345 | 34 | － | 1452 | 1650 |
| 2 | CFIN | －1396 | －1650 | 35 | － | 1292 | 1650 |
| 3 | CFOUT | －1236 | －1650 | 36 | SEG14 | 1132 | 1650 |
| 4 | S1 | －1071 | －1650 | 37 | SEG15 | 972 | 1650 |
| 5 | S2 | －901 | －1650 | 38 | SEG16 | 812 | 1650 |
| 6 | S3 | －731 | －1650 | 39 | SEG17 | 652 | 1650 |
| 7 | S4 | －561 | －1650 | 40 | SEG18 | 492 | 1650 |
| 8 | K1 | －391 | －1650 | 41 | SEG19 | 332 | 1650 |
| 9 | K2 | －221 | －1650 | 42 | SEG20 | 172 | 1650 |
| 10 | K3 | －51 | －1650 | 43 | SEG21 | 12 | 1650 |
| 11 | K4 | 119 | －1650 | 44 | SEG22 | －148 | 1650 |
| 12 | M1 | 289 | －1650 | 45 | SEG23 | －308 | 1650 |
| 13 | M2 | 459 | －1650 | 46 | COM4 | －468 | 1650 |
| 14 | M3 | 629 | －1650 | 47 | COM3 | －628 | 1650 |
| 15 | M4 | 799 | －1650 | 48 | COM2 | －788 | 1650 |
| 16 | N1 | 1034 | －1650 | 49 | COM1 | －948 | 1650 |
| 17 | N2 | 1333 | －1650 | 50 | CUP1 | －1108 | 1650 |
| 18 | N3 | 1854 | －1234 | 51 | CUP2 | －1268 | 1650 |
| 19 | N4 | 1854 | －935 | 52 | RES | －1854 | 1488 |
| 20 | TST | 1854 | －705 | 53 | INT | －1854 | 1323 |
| 21 | SEG01 | 1854 | －545 | 54 | SO1 | －1854 | 1153 |
| 22 | SEG02 | 1854 | －385 | 55 | SO2 | －1854 | 983 |
| 23 | SEG03 | 1854 | －225 | 56 | SO3 | －1854 | 813 |
| 24 | SEG04 | 1854 | －65 | 57 | SO4 | －1854 | 643 |
| 25 | SEG05 | 1854 | 95 | 58 | P1 | －1854 | 473 |
| 26 | SEG06 | 1854 | 255 | 59 | P2 | －1854 | 303 |
| 27 | SEG07 | 1854 | 415 | 60 | P3 | －1854 | 133 |
| 28 | SEG08 | 1854 | 575 | 61 | P4 | －1854 | －37 |
| 29 | SEG09 | 1854 | 735 | 62 | XTOUT | －1854 | －202 |
| 30 | SEG10 | 1854 | 895 | 63 | XTIN | －1854 | －362 |
| 31 | SEG11 | 1854 | 1055 | 64 | VDD2 | －1854 | －594 |
| 32 | SEG12 | 1854 | 1215 | 65 | VDD1 | －1854 | －898 |
| 33 | SEG13 | 1854 | 1375 | 66 | VSS | －1854 | －1122 |

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## System Block Diagram



## Mask options overview

Mask options are provided to allow the microcontroller hardware functions to closely match the specifications of the end product．The user can select any combination of options desired．In addition，these microcontroller also provide，as a mask option，a segment PLA function that can set up a correspondence，in single－segment units，between the operation of independently developed software and the actual LCD segments．

Oscillator Circuit Options
－Oscillator selection：Selects oscillator specifications appropriate for the application． 1：CF，2：EXT，3：RC，4：Crystal，5：CF \＆crystal，6：EXT \＆crystal， 7 RC \＆crystal
－CF／EXT frequency：Selects the frequency of the CF（ceramic）or external oscillator． 1： $400 \mathrm{kHz} / 10 \mu \mathrm{~s}, 2: 800 \mathrm{kHz} / 5 \mu \mathrm{~s}, 3: 2 \mathrm{MHz} / 2 \mu \mathrm{~s}, 4: 4 \mathrm{MHz} / 1 \mu \mathrm{~s}, 5: 6 \mathrm{MHz} / 0.7 \mu \mathrm{~s}$
－RC frequency：Selects the frequency of the RC（resistor／capacitor）oscillator． 1： $400 \mathrm{kHz} / 10 \mu \mathrm{~s}, 2: 800 \mathrm{kHz} / 5 \mu \mathrm{~s}$
－Xtal selection：Selects the frequency of the crystal oscillator． 1： $32 \mathrm{kHz} / 122 \mu \mathrm{~s}, 2: 38 \mathrm{kHz} / 105 \mu \mathrm{~s}, 3: 65 \mathrm{kHz} / 61 \mu \mathrm{~s}$
－Crystal oscillator specification：Selects the Rd and Cd used with the crystal oscillator．
1：Internal Rd and Cd used，2：Internal Rd and Cd unused

## LCD Controller／Driver Options

－LCD driver：Selects the LCD driver／controller operating mode appropriate for the drive technique used by the LCD panel used．
1：Static，2：Duplex，3：1／2B－1／3D，4：1／2B－1／4D，5：1／3B－1／3D，6：1／3B－1／4D， 7 Unused
－LCD frequency：Selects the drive frequency（frame frequency）appropriate for the LCD panel used．
1：Slow，2：Typ，3：Fast

## Base Timer Options

－Base timer overflow signal：Selects the base timer basic frequency．
1：DIVIN divided by 8192 or 32768 ，2：DIVIN divided by 4096 or 16384

## Serial Interface Options

－SIO counter internal clock speed：Selects the frequency of the internal clock used by the serial interface．
1：1 machine cycle， $2: 2$ machine cycles，3：4 machine cycles

## INT Pin Options

－INT pin resistor：Selects the type of INT pin input circuit appropriate for the application 1：Pulled down，2：Pulled up，3：Open
－INT pin interrupt edge：Selects the input level at which the INT external interrupt pin operates． 1：Falling edge（high to low），2：Rising edge（low to high）
－INT pin hold transistor：Selects whether or not the level hold function built into the INT pin circuit is used．
1：Low／high level hold transistor used，2：Low／high level hold transistor unused

## Reset Options

－RESET pin resistor：Selects the type of RES pin input circuit appropriate for the application 1：Pulled down（high resistance）， 2 Pulled up（low resistance），3：Open（high resistance），4：Open（low resistance）
－Internal reset：Selects whether or not the internal reset circuit should be used in conjunction with the external reset function．
1：Used，2：Unused

## Port Internal Resistor Options

－Resistor connection selection：Selects the programmable resistors and the level hold functions that are built into the input ports．
1．Pull－down resistor，2：Pull－up resistor
Port Built－in Level Hold Function Options（Selected in 4－bit units）：These depend on which of the above－described options were selected．
－Port S hold transistor：Selects whether or not the port $S$ level hold function is used．
1：Low／high level hold transistors used，2：Low／high level hold transistors unused
－Port K hold transistors：Selects whether or not the port K level hold function is used．
1：Low／high level hold transistors used，2：Low／high level hold transistors unused
－Port M hold transistors：Selects whether or not the port M level hold function is used．
1：Low／high level hold transistors used，2：Low／high level hold transistors unused
－Port P hold transistors：Selects whether or not the port P level hold function is used．
1：Low／high level hold transistors used，2：Low／high level hold transistors unused
－Port SO hold transistors：Selects whether or not the port SO level hold function is used．
1：Low／high level hold transistors used，2：Low／high level hold transistors unused

## Port N Options

－N1 pin output type：Selects the type of the port N1 output circuit．
1：CMOS type，2：N－channel type
－N2 pin output type：Selects the type of the port N2 output circuit．
1：CMOS type，2：N－channel type
－N3 pin output type：Selects the type of the port N3 output circuit． 1：CMOS type，2：N－channel type
－N4 pin output type：Selects the type of the port N4 output circuit．
1：CMOS type，2：N－channel type
－Port N initial output state：Selects the output levels for port N （N1 through N4）when the reset signal is applied． 1：High level or off，2：Low level

## Pin Functions

| Pin | I／O | Function | State during a reset |
| :---: | :---: | :---: | :---: |
| VSS | － | Ground（－） |  |
| VDD | － | Power supply（＋） |  |
| VDD1 <br> VDD2 | － | －LCD power supply connections <br> －The external handling of these pins differs depending on the LCD drive bias technique used． |  |
| CUP1 <br> CUP2 | — | －LCD drive pins <br> －The external handling of these pins differs depending on the LCD drive bias technique used． |  |
| $\begin{aligned} & \text { CFIN } \\ & \text { CFOUT } \end{aligned}$ | Input <br> Output | －OSC1（fast mode）oscillator element connections CF specifications： 400 kHz to 6 MHz RC specifications： 400 kHz to 800 kHz EXT specifications： 200 kHz to 4 MHz |  |
| $\begin{aligned} & \text { XTIN } \\ & \text { XTOUT } \end{aligned}$ | Input <br> Output | －OSC2（slow mode）oscillator element connections Xtal：32，38，or 65 kHz |  |
| INT | Input | －1－bit input <br> －External interrupt input <br> －The input circuit type and the interrupt level are set in the mask options． （Pulled up，pulled down，or open） （Rising edge or falling edge） <br> －A level hold function，which is designed to prevent input floating states from occurring，is also available as an option． | －Interrupt reception：disabled <br> －Level hold function：operational |
| $\begin{aligned} & \text { S1 } \\ & \text { S2 } \\ & \text { S3 } \\ & \text { S4 } \end{aligned}$ | Input <br> Input <br> Input <br> Input | －4－bit input port <br> －Pull－up and pull－down resistors，which can be enabled or disabled under program control in a single port unit，are built in． <br> －Input signal transition detection circuits and chattering exclusion circuits， which can be enabled or disabled under program control in 1－bit units，are built in． <br> －The chattering exclusion time differs depending on the oscillator specifications． <br> When a 32.768 kHz crystal oscillator is used the time will be 1.95 or 7.8 ms ． <br> －A level hold function，which is designed to prevent input floating states from occurring on these pins，is also available as an option． | －Pull－down or pull－up resistors：enabled （After the reset is cleared：disabled） <br> －Level hold function：operation disabled （After the reset is cleared：operation starts） |
| $\begin{aligned} & \text { K1 } \\ & \text { K2 } \\ & \text { K3 } \\ & \text { K4 } \end{aligned}$ | $\begin{aligned} & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \end{aligned}$ | －4－bit I／O port <br> －Pull－up and pull－down resistors，which can be enabled or disabled under program control in a single port unit，are built in． <br> －Input signal transition detection circuits and chattering exclusion circuits， which can be enabled or disabled under program control in a single port unit，are built in． <br> －The chattering exclusion time differs depending on the oscillator specifications． <br> When a 32.768 kHz crystal oscillator is used the time will be 1.95 or 7.8 ms ． <br> －Output circuit type：CMOS <br> －A level hold function，which is designed to prevent input floating states from occurring on these pins，is also available as an option． | －Input mode <br> －Pull－down or pull－up resistors：enabled （After the reset is cleared：disabled） <br> －Level hold function：operation disabled （After the reset is cleared：operation starts） <br> －Output latch data：high |

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| Pin | I／O | Function | State during a reset |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \mathrm{SO} 1 \\ & \mathrm{SO} 2 \\ & \mathrm{SO} 3 \\ & \mathrm{SO} 4 \end{aligned}$ | $\begin{aligned} & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \end{aligned}$ | －4－bit I／O port（also used for the serial interface） <br> SO1：Serial interface input <br> SO2：Serial interface output <br> SO3：Serial interface clock <br> －The serial interface can also be used as a 2－wire interface． <br> －When the serial interface function is not used，the SO4 pin can be used to clear halt mode or as an interrupt pin． <br> －Pull－up and pull－down resistors，which can be enabled or disabled under program control in a single port unit，are built in． <br> －The output circuit type can be switched under program control in a single port unit．（CMOS／n－channel） <br> －A level hold function，which is designed to prevent input floating states from occurring on these pins，is also available as an option． | －Input mode <br> －Pull－down or pull－up resistors：enabled （After the reset is cleared：disabled） <br> －Level hold function：operation disabled （After the reset is cleared：operation starts） <br> －4－bit parallel mode <br> －Output latch data：high |
| $\begin{aligned} & \text { M1 } \\ & \text { M2 } \\ & \text { M3 } \\ & \text { M4 } \end{aligned}$ | $\begin{aligned} & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \\ & 1 / O \end{aligned}$ | －4－bit I／O port <br> －Pull－up and pull－down resistors，which can be enabled or disabled under program control in a single port unit，are built in． <br> －The output circuit type can be switched under program control in a single port unit．（CMOS／n－channel） <br> －The M4 pin functions as a clock input when timer 2 is operated in event counter mode． <br> －A level hold function，which is designed to prevent input floating states from occurring on these pins，is also available as an option． | －Input mode <br> －Pull－down or pull－up resistors：enabled （After the reset is cleared：disabled） <br> －Level hold function：operation disabled （After the reset is cleared：operation starts） <br> －Output latch data：high |
| $\begin{aligned} & \text { P1 } \\ & \text { P2 } \\ & \text { P3 } \\ & \text { P4 } \end{aligned}$ | $\begin{aligned} & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \end{aligned}$ | －4－bit I／O port <br> －Pull－up and pull－down resistors，which can be enabled or disabled under program control in a single port unit，are built in． <br> －The output circuit type can be switched under program control in a single port unit．（CMOS／n－channel） <br> －A level hold function，which is designed to prevent input floating states from occurring on these pins，is also available as an option． | －Input mode <br> －Pull－down or pull－up resistors：enabled （After the reset is cleared：disabled） <br> －Level hold function：operation disabled （After the reset is cleared：operation starts） <br> －Output latch data：high |
| $\begin{aligned} & \text { N1 } \\ & \text { N2 } \\ & \text { N3 } \\ & \text { N4 } \end{aligned}$ | Output <br> Output <br> Output <br> Output | －4－bit output port <br> －The output circuit type can be switched under program control in 1－bit units．（CMOS／n－channel） <br> －This port handles medium－level voltages when the $n$－channel open－drain output circuit type is selected． <br> －N3 is the remote controller carrier signal output pin． <br> －N4 is the alarm pulse signal output pin． | －The output levels are specified as mask options |
| $\begin{aligned} & \text { SEG1 } \\ & \text { to } \\ & \text { SEG23 } \end{aligned}$ | Output <br> Output | －LCD panel segment drive pins <br> －Six drive techniques are supported． <br> －These pins can be used as general－purpose outputs（either CMOS， p－channel，or n－channel）by specifying mask options． <br> －Any combination of LCD drive and general－purpose output pins can be set up． | －The LCD drive state is specified as a mask option． （Either all lit or all off．） <br> －The LCD driver／controller either operates or stops depending on the oscillator specifications and other mask options． <br> －The states of those pins set up as general－purpose outputs are determined by the mask options． If all segments lit is specified：High or off． If all segments off is specified：Low or off． |
| COM1 <br> COM2 <br> COM3 <br> COM4 | Output <br> Output <br> Output <br> Output | －LCD panel common plate drive pins <br> －One of four pins COM1 to COM4 is selected according to the LCD drive duty technique used． <br> －The LCD drive frequency（frame frequency）is determined by the mask option． | －The LCD driver／controller either operates or stops depending on the oscillator specifications and other mask options |
| RES | Input | －Microcontroller reset input <br> Applications must apply the reset signal level for at least $200 \mu \mathrm{~s}$ ． <br> －The input circuit and the reset level are specified as mask options． |  |
| TST | Input | －Test input <br> －This pin must be tied to the VSS level（the minus side of the power supply）． |  |

## Specifications

## Absolute Maximum Ratings at $\mathbf{T a}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$

| Parameter | Symbol | Conditions and applicable pins | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Maximum supply voltage | $V_{D D}$ |  | －0．3 |  | ＋7．0 | V |
|  | $\mathrm{V}_{\mathrm{DD} 1}$ |  | －0．3 |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
|  | $\mathrm{V}_{\mathrm{DD}}{ }^{2}$ |  | －0．3 |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
| Maximum input voltage | V11 | Allowable levels in the specified circuit．XTIN，CFIN | Voltages up to the generated voltage are allowed． |  |  |  |
|  | V 2 | S1 to 4, K1 to 4, P1 to 4, SO1 to 4, RES，INT，TST （With the K，P，M，and SO ports in input mode） | －0．3 |  | $V_{D D}+0.3$ | V |
| Maximum output voltage | $\mathrm{V}_{\mathrm{O}} 1$ | Allowable levels in the specified circuit．XTOUT，CFOUT | Voltages up to the generated voltage are allowed |  |  |  |
|  | $\mathrm{V}_{\mathrm{O}} 2$ | K1 to 4，P1 to 4，SO1 to 4，N1 to 4，CUP1，CUP2， Seg1 to 23，COM1 to 4 <br> （With the K，P，M，and SO ports in output mode） | －0．3 |  | $V_{D D}+0.3$ | V |
|  | $\mathrm{V}_{0} 3$ | With the open－drain specifications N1 o 4 （Nch） | －0．3 |  | ＋16 | V |
| Pin output current | lo1 | Per pin．K1 to 4，P1 to 4，M1 to 4，SO1 to 4 | 0 |  | ＋10 | mA |
|  | 102 |  | －10 |  | 0 | mA |
|  | 103 |  | 0 |  | 5 | mA |
|  | 104 |  | －5 |  | 0 | mA |
|  | $\Sigma \mathrm{l}_{0} 1$ | Total current for all pins：K1 to 4，P1 to 4，M1 to 4，SO1 to 4 N1 to 4，Seg1 to 35 |  |  | 40 | mA |
|  | $\Sigma \mathrm{l}_{0} 2$ |  | －40 |  |  | mA |
| Allowable power dissipation | Pd max | QFP64E（QIP64E）flat package |  |  | 300 | mW |
| Operating temperature | Topr |  | －30 |  | ＋70 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | Tstg |  | －55 |  | ＋125 | ${ }^{\circ} \mathrm{C}$ |

Allowable Operating Ranges at $\mathrm{Ta}=-\mathbf{3 0}$ to $+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$

| Parameter | Symbol | Conditions and applicable pins | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Supply voltage | $V_{D D}$ | LCD unused specifications： $\mathrm{V}_{\mathrm{DD}} 1=\mathrm{V}_{\mathrm{DD}}{ }^{2}=\mathrm{V}_{\mathrm{DD}}$ | 2.0 |  | 6.0 | V |
|  |  | Static drive specifications： $\mathrm{V}_{\mathrm{DD}} 1=\mathrm{V}_{\mathrm{DD}} 2=\mathrm{V}_{\mathrm{DD}}$ | 2.0 |  | 6.0 | V |
|  |  | $1 / 2$ bias specifications：$V_{D D} 1=V_{D D} 2 \approx 1 / 2 V_{D D}$ | 2.8 |  | 6.0 | V |
|  |  | $1 / 3$ bias specifications：$V_{D D} 1 \approx 2 \times 1 / 3 \mathrm{~V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{DD}} 2 \approx 1 / 3 \mathrm{~V}_{\mathrm{DD}}$ | 2.8 |  | 6.0 | V |
| Memory retention supply voltage | $\mathrm{V}_{\mathrm{HD}}$ | Voltages at which the RAM and register contents are retained＊ | 2.0 |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
| High－level input voltage | $\mathrm{V}_{\mathrm{H}}{ }^{1}$ | S1 to 4，K1 to 4，P1 to 4，M1 to 4，SO1 to 4，INT （With the K，P，M，and SO ports in input mode） | $0.7 \mathrm{~V}_{\mathrm{DD}}$ |  | $V_{D D}$ | V |
| Low－level input voltage | $\mathrm{V}_{\text {IL }} 1$ | S1 to 4，K1 to 4，P1 to 4，M1 to 4，SO1 to 4，INT （With the K，P，M，and SO ports in input mode） | 0 |  | 0．3 V ${ }_{\text {DD }}$ | V |
| High－level input voltage | $\mathrm{V}_{\mathrm{HH}^{2}}$ | RES | $0.75 \mathrm{~V}_{\mathrm{DD}}$ |  | $V_{D D}$ | V |
| Low－level input voltage | $\mathrm{V}_{\text {IL }} 2$ | RES | 0 |  | $0.25 V_{\text {DD }}$ | V |
| High－level input voltage | $\mathrm{V}_{\mathrm{IH}^{3}}$ | CFIN | $0.75 \mathrm{~V}_{\mathrm{DD}}$ |  | $V_{D D}$ | V |
| Low－level input voltage | $\mathrm{V}_{\text {IL }} 3$ | CFIN | 0 |  | $0.25 \mathrm{~V}_{\mathrm{DD}}$ | V |
| Operating frequency 1 | fopg1 | $\mathrm{V}_{\mathrm{DD}}=2.0 \mathrm{~V}$ to $6.0 \mathrm{~V}, \mathrm{XTIN} / \mathrm{XOUT}$ ， 32 kHz Crystal oscillator | 32 |  | 33 | kHz |
| Operating frequency 2 | fopg2 | $\mathrm{V}_{\mathrm{DD}}=2.2 \mathrm{~V}$ to 6.0 V ，XTIN／XOUT， 38 kHz Crystal oscillator | 37 |  | 39 | kHz |
| Operating frequency 3 | fopg3 |  | 60 |  | 70 | kHz |
| Operating frequency 4 | fopg4 | $\mathrm{V}_{\mathrm{DD}}=2.2 \mathrm{~V}$ to 6．0 V CFIN，CFOUT CF specifications | 390 |  | 810 | kHz |
| Operating frequency 5 | fopg5 | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ to 6．0 V CFIN，CFOUT CF specifications | 390 |  | 1200 | kHz |
| Operating frequency 6 | fopg6 | $\mathrm{V}_{\mathrm{DD}}=2.8 \mathrm{~V}$ to 6．0 V CFIN，CFOUT CF specifications | 390 |  | 4200 | kHz |
| Operating frequency 7 | fopg7 | $\mathrm{V}_{\mathrm{DD}}=4.5 \mathrm{~V}$ to 6．0 V CFIN，CFOUT CF specifications | 390 |  | 6000 | kHz |
| Operating frequency 8 | fopg8 | $\mathrm{V}_{\mathrm{DD}}=4.5 \mathrm{~V}$ to 6．0 V CFIN，CFOUT RC specifications | 400 |  | 800 | kHz |
| Operating frequency 9 | fopg9 | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}$ to 6．0 V CFIN，CFOUT EXT specifications | 190 |  | 4000 | kHz |
| Operating frequency 10 | fopg10 | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}$ to 6.0 V Pins $\mathrm{SO1}$ and $\mathrm{SO3}$（in serial interface mode） Rising and falling edges on the input signal and clock waveform must be $\leq 10 \mu \mathrm{~s}$ | DC |  | 200 | kHz |

[^1]
## Electrical Characteristics at $\mathbf{T a}=\mathbf{- 3 0}$ to $+\mathbf{7 0}{ }^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=\mathbf{2 . 5}$ to $\mathbf{3 . 2} \mathrm{V}, \mathrm{V}_{\mathrm{SS}}=\mathbf{0} \mathrm{V}$

| Parameter | Symbol | Conditions and applicable pins | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Input resistance | $\mathrm{R}_{\text {IN }} 1 \mathrm{~A}$ | $\mathrm{V}_{\mathrm{IN}}=0.2 \mathrm{~V}_{\mathrm{DD}}$ ，Low level hold transistor＊ | 60 | 300 | 1200 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{~B}$ | Pull－down resistor＊ | 30 | 150 | 500 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{C}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}_{\mathrm{DD}}$ ，High level hold transistor＊ | 60 | 300 | 1200 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{D}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，Pull－up resistor＊ | 30 | 150 | 500 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{~A}$ | $\mathrm{V}_{\text {IN }}=0.2 \mathrm{~V}_{\mathrm{DD}}$ ，INT pin low level hold transistor | 60 | 300 | 1200 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{~B}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，INT pin pull－down resistor | 300 | 1500 | 5000 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{C}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}_{\mathrm{DD}}$ ，INT pin high level hold transistor | 60 | 300 | 1200 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{D}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，INT pin pull－up resistor | 300 | 1500 | 5000 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }} 3$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，RES pin pull－down resistor | 10 | 30 | 50 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }} 4$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，RES pin pull－up resistor | 10 | 30 | 50 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }} 5$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ ，TST pin pull－down resistor | 10 | 30 | 50 | $\mathrm{k} \Omega$ |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 1$ | $\mathrm{I}_{\mathrm{OH}}=-500 \mu \mathrm{~A}, \mathrm{~N} 1$ to 4 | $V_{D D}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 1$ | $\mathrm{I}_{\text {OL }}=1.0 \mathrm{~mA}, \mathrm{~N} 1$ to 4 |  |  | 0.5 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{2}$ | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}, \mathrm{~K} 1$ to 4 ，P1 to 4 ，M1 to 4 ，SO1 to 4 （With the K，P，M，and SO ports in output mode） | $V_{D D}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\mathrm{OL}}{ }^{2}$ | $\mathrm{I}_{\mathrm{OL}}=400 \mu \mathrm{~A}, \mathrm{~K} 1$ to $4, \mathrm{P} 1$ to $4, \mathrm{M} 1$ to 4 ，SO1 to 4 （With the K，P，M，and SO ports in output mode） |  |  | 0.5 | V |
| Output off leakage current | ｜OFF｜ | $\mathrm{V}_{\mathrm{OH}}=10.5 \mathrm{~V}, \mathrm{~N} 1$ to 4 （Open specifications） |  |  | 1.0 | $\mu \mathrm{A}$ |
| Segment Port Output Impedances［CMOS output port mode］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{3}$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ ，Seg 1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 3$ | $\mathrm{I}_{\mathrm{OL}}=100 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.5 | V |
| ［P－channel open－drain output port mode］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 3$ | $\mathrm{I}_{\text {OH }}=-100 \mu \mathrm{~A}$ ，Seg 1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.5$ |  |  | V |
| Output off leakage current | ｜ OFF ｜ | $\mathrm{V}_{\mathrm{OL}}=\mathrm{V}_{\text {SS }}$ ，Seg 1 to 23 |  |  | 1.0 | $\mu \mathrm{A}$ |
| ［ N －channel open－drain output port mode］ |  |  |  |  |  |  |
| Low－level output voltage | $\mathrm{V}_{\mathrm{OL}} 3$ | $\mathrm{I}_{\text {OL }}=100 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.5 | V |
| Output off leakage current | ｜ OFF ｜ | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}$ ，Seg 1 to 23 |  |  | 1.0 | $\mu \mathrm{A}$ |
| ［Static drive］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 4$ | $\mathrm{I}_{\mathrm{OH}}=-20 \mu \mathrm{~A}$ ，Seg 1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 4$ | $\mathrm{I}_{\mathrm{LL}}=20 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.2 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 5$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}, \mathrm{COM} 1$ | $V_{D D}-0.2$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\mathrm{OL}} 5$ | $\mathrm{I}_{\text {OL }}=100 \mu \mathrm{~A}, \mathrm{COM} 1$ |  |  | 0.2 | V |

Note＊：The 20 pins S1 to S4，K1 to K4，P1 to P4，M1 to M4，and SO1 to SO4．

## Electrical Characteristics at $\mathbf{T a}=\mathbf{- 3 0}$ to $+\mathbf{7 0}{ }^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=\mathbf{3 . 0}$ to $4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathbf{0} \mathrm{V}$

| Parameter | Symbol | Conditions and applicable pins | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Input resistance | $\mathrm{R}_{\text {IN }} 1 \mathrm{~A}$ | $\mathrm{V}_{\mathrm{IN}}=0.2 \mathrm{~V}_{\mathrm{DD}}$ ，Low level hold transistor＊ | 35 | 200 | 800 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{~B}$ | Pull－down resistor＊ | 15 | 80 | 300 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{C}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}_{\mathrm{DD}}$ ，High level hold transistor＊ | 35 | 200 | 800 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{D}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，Pull－up resistor＊ | 15 | 80 | 300 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{~A}$ | $\mathrm{V}_{\text {IN }}=0.2 \mathrm{~V}_{\mathrm{DD}}$ ，INT pin low level hold transistor | 35 | 200 | 800 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{~B}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，INT pin pull－down resistor | 150 | 800 | 3000 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\mathrm{IN}} 2 \mathrm{C}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}_{\mathrm{DD}}$ ，INT pin high level hold transistor | 35 | 200 | 800 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\mathrm{IN}} 2 \mathrm{D}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {SS }}$ ，INT pin pull－up resistor | 150 | 800 | 3000 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 3$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，RES pin pull－down resistor | 10 | 30 | 50 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 4$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，RES pin pull－up resistor | 10 | 30 | 50 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 5$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，TST pin pull－down resistor | 10 | 30 | 50 | $\mathrm{k} \Omega$ |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{1}$ | $\mathrm{I}_{\mathrm{OH}}=-1.0 \mathrm{~mA}, \mathrm{~N} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 1$ | $\mathrm{I}_{\mathrm{OL}}=2.0 \mathrm{~mA}, \mathrm{~N} 1$ to 4 |  |  | 0.5 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{2}$ | $\mathrm{I}_{\mathrm{OH}}=-500 \mu \mathrm{~A}, \mathrm{~K} 1$ to 4 ， P 1 to 4 ，M1 to 4 ，SO1 to 4 （With the K，P，M，and SO ports in output mode） | $V_{D D}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\mathrm{OL}}{ }^{2}$ | $\mathrm{IOL}=500 \mu \mathrm{~A}, \mathrm{~K} 1$ to $4, \mathrm{P} 1$ to $4, \mathrm{M} 1$ to $4, \mathrm{SO} 1$ to 4 （With the K，P，M，and SO ports in output mode） |  |  | 0.5 | V |
| Output off leakage current | ｜｜OFF｜｜ | $\mathrm{V}_{\mathrm{OH}}=10.5 \mathrm{~V}$ ， N 1 to 4 （Open specifications） |  |  | 1.0 | $\mu \mathrm{A}$ |

Segment Port Output Impedances
［CMOS output port mode］

| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 3$ | $\mathrm{I}_{\mathrm{OH}}=-300 \mu \mathrm{~A}$ ，Seg 1 to 23 | $V_{D D}-0.5$ |  | V |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 3$ | $\mathrm{I}_{\mathrm{OL}}=300 \mu \mathrm{~A}$ ，Seg 1 to 23 |  | 0.5 | V |
| ［P－channel open－drain output port mode］ |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 3$ | $\mathrm{I}_{\text {OH }}=-300 \mu \mathrm{~A}$ ，Seg 1 to 23 | $V_{D D}-0.5$ |  | V |
| Output off leakage current | ｜ OFF ｜ | $\mathrm{V}_{\text {OL }}=\mathrm{V}_{\text {SS }}$ ，Seg 1 to 23 |  | 1.0 | $\mu \mathrm{A}$ |
| ［ N －channel open－drain output port mode］ |  |  |  |  |  |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 3$ | $\mathrm{I}_{\text {OL }}=300 \mu \mathrm{~A}$ ，Seg 1 to 23 |  | 0.5 | V |
| Output off leakage current | ｜ OFF ｜ | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}$ ，Seg 1 to 23 |  | 1.0 | $\mu \mathrm{A}$ |

## ［Static drive］

| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 4$ | $\mathrm{I}_{\mathrm{OH}}=-20 \mu \mathrm{~A}$, Seg 1 to 23 | $\mathrm{~V}_{\mathrm{DD}}-0.2$ |  | V |
| :--- | :---: | :--- | :--- | :--- | :---: |
| Low－level output voltage | $\mathrm{V}_{\mathrm{OL}} 4$ | $\mathrm{I}_{\mathrm{OL}}=20 \mu \mathrm{~A}, \operatorname{Seg} 1$ to 23 |  |  | 0.2 |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 5$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}, \mathrm{COM} 1$ | $\mathrm{~V}_{\mathrm{DD}}-0.2$ |  | V |
| Low－level output voltage | $\mathrm{V}_{\mathrm{OL}} 5$ | $\mathrm{I}_{\mathrm{OL}}=100 \mu \mathrm{~A}, \mathrm{COM} 1$ |  | V |  |

［1／2 bias drive］

| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 4$ | $\mathrm{I}_{\mathrm{OH}}=-20 \mu \mathrm{~A}$ ，Seg 1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  | V |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 4$ | $\mathrm{I}_{\mathrm{OL}}=20 \mu \mathrm{~A}$ ，Seg 1 to 23 |  | 0.2 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 5$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  | V |
| Output middle－level voltage | $\mathrm{V}_{\mathrm{OM}}$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\text {DI }} / 2-0.2$ | $\mathrm{V}_{\mathrm{DD}} / 2+0.2$ | V |
|  |  | $\mathrm{IOL}=100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | －0．2 | ＋0．2 | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 5$ | $\mathrm{I} \mathrm{OL}=100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 |  | 0.2 | V |
| ［1／3 bias drive］ |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 4$ | $\mathrm{I}_{\mathrm{OH}}=-20 \mu \mathrm{~A}$ ，Seg1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  | V |
| Output middle－level voltage | $\mathrm{V}_{\mathrm{OM}}{ }^{1-1}$ | $\mathrm{IOH}=-20 \mu \mathrm{~A}$ ，Seg1 to 23 | $2 V_{D D} / 3-0.2$ | $2 \mathrm{~V}_{\text {DD }} / 3+0.2$ | V |
|  | $\mathrm{V}_{\text {OM }}{ }^{1-2}$ | $\mathrm{IOL}=20 \mu \mathrm{~A}$ ，Seg1 to 23 | $\mathrm{V}_{\mathrm{DD}} / 3-0.2$ | $\mathrm{V}_{\mathrm{DD}} / 3+0.2$ | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 4$ | I OL $=20 \mu \mathrm{~A}$ ，Seg 1 to 23 |  | 0.2 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 6$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  | V |
| Output middle－level voltage | $\mathrm{V}_{\text {OM }}{ }^{2-1}$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $2 V_{D D} / 3-0.2$ | $2 \mathrm{~V}_{\text {D }} 3+0.2$ | V |
|  | $\mathrm{V}_{\text {OM }}{ }^{2-2}$ | $\mathrm{IOL}=100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}} / 3-0.2$ | $\mathrm{V}_{\mathrm{DD}} / 3+0.2$ | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 6$ | $\mathrm{IOL}=100 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 |  | 0.2 | V |

Note＊：The 20 pins S1 to S4，K1 to K4，P1 to P4，M1 to M4，and SO1 to SO4．
Continued on next page．

Continued from preceding page．

| Parameter | Symbol | Conditions and applicable pins |  | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| Supply leakage current | ILEK1 | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ |  |  | 0.2 | 1.0 | $\mu \mathrm{A}$ |
|  | ILEK2 | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  | 1.0 | 5.0 | $\mu \mathrm{A}$ |
| Input leakage current | I OFF | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~S} 1$ to $4, \mathrm{~K} 1$ to $4, \mathrm{P} 1$ to $4, \mathrm{M} 1$ to 4 ，SO1 to 4 ，INT，RES <br> （With the K，P，M，and SO ports in input mode and with the open specifications selected for the INT and RES pins．） |  |  |  | 1.0 | $\mu \mathrm{A}$ |
|  |  |  |  | －1．0 |  |  | $\mu \mathrm{A}$ |
| Output voltage 1 | $V_{D D 1-1}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{C} 1=\mathrm{C} 2=0,1 \mu \mathrm{~F}, \mathrm{~V}_{\mathrm{DD}} 1=\mathrm{V}_{\mathrm{DD}} 2,1 / 2 \text { Bias, } \\ & \text { fopg }=32.768 \mathrm{kHz} \end{aligned}$ |  | 1.3 | 1.5 | 1.7 | V |
| Supply current 1 | $\\|_{\text {ID }} 11-1$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | Crystal oscillator specifications Crystal： 32 kHz （Cd and Rd built in） $\mathrm{Cg}=11 \mathrm{pF}, \mathrm{Cl}=31 \mathrm{k} \Omega$ <br> Halt mode，LCD＝ $1 / 3$ bias |  | 7 | 15 | $\mu \mathrm{A}$ |
|  | $\\|_{\text {DD }} \mid 1-2$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 20 | $\mu \mathrm{A}$ |
| Supply current 2 | ｜lido ${ }^{\text {d－1 }}$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | CF oscillator specifications CF： 455 kHz <br> $\mathrm{Ccg}=\mathrm{Ccd}=220 \mathrm{pF}$ <br> Halt mode，LCD $=1 / 3$ bias |  | 100 | 150 | $\mu \mathrm{A}$ |
|  | $\|l\| l o_{\text {D }}$｜2－2 | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 200 | $\mu \mathrm{A}$ |
| Supply current 3 |  | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | CF oscillator specifications CF： 1000 kHz $\mathrm{Ccg}=\mathrm{Ccd}=100 \mathrm{pF}$ <br> Halt mode，LCD $=1 / 3$ bias |  | 150 | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 300 | $\mu \mathrm{A}$ |
| Supply current 4 | $\\|_{\text {l }}^{\text {D }}$｜4－1 | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | $\begin{aligned} & \text { CF oscillator specifications } \\ & \mathrm{CF}: 4000 \mathrm{kHz} \\ & \mathrm{Ccg}=\mathrm{Ccd}=33 \mathrm{pF} \\ & \text { Halt mode, LCD }=1 / 3 \text { bias } \end{aligned}$ |  | 160 | 220 | $\mu \mathrm{A}$ |
|  | $\\|_{\text {DD }} \mid 4-2$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 330 | $\mu \mathrm{A}$ |
| Oscillator startup voltage | $\left\|\mathrm{V}_{\text {STT }}\right\|$ | Tstt $\leq 5 \mathrm{~s}$ | Crystal oscillator specifications Crystal： 32 kHz （Cd and Rd built in） $\mathrm{Cg}=11 \mathrm{pF}, \mathrm{Cl}=31 \mathrm{k} \Omega$ |  |  | 2.2 | V |
| Oscillator hold voltage | $\left\|\mathrm{V}_{\text {HOLD }}\right\|$ |  |  | 2.0 |  | 6.0 | V |
| Oscillator startup time | $\left\|T_{\text {STT }}\right\|$ | $\mathrm{V}_{\mathrm{DD}}=2.2 \mathrm{~V}$ |  |  |  | 5 | s |
| Oscillator stability | $\Delta f$ | $\mathrm{V}_{\mathrm{DD}}=2.95$ to 3.05 V |  |  |  | 3 | ppm |
| Oscillator startup voltage | $\left\|\mathrm{V}_{\text {STT }}\right\|$ | Tstt $\leq 5 \mathrm{~s}$ | Crystal oscillator specifications Crystal： 38 or 65 kHz $\mathrm{XCg}=12 \mathrm{pF}, \mathrm{Cl} \leq 31 \mathrm{k} \Omega$ |  |  | 2.4 | V |
| Oscillator hold voltage | $\left\|\mathrm{V}_{\text {HOLD }}\right\|$ |  |  | 2.2 |  | 6.0 | V |
| Oscillator startup time | $\left\|T_{\text {STT }}\right\|$ | $\mathrm{V}_{\mathrm{DD}}=2.4 \mathrm{~V}$ |  |  |  | 5 | s |
| Oscillator startup voltage | $\left\|\mathrm{V}_{\text {STT }}\right\|$ | $\mathrm{Tstt} \leq 30 \mathrm{~ms}$ | CF oscillator specifications <br> With a $455-\mathrm{kHz}$ CF element used $\mathrm{Ccg}=\mathrm{Ccd}=220 \mathrm{pF}$ |  |  | 2.2 | V |
| Oscillator hold voltage | $\left\|\mathrm{V}_{\text {HOLD }}\right\|$ |  |  | 2.1 |  | 6.0 | V |
| Oscillator startup time | $\left\|T_{\text {STT }}\right\|$ | $\mathrm{V}_{\mathrm{DD}}=2.2 \mathrm{~V}$ |  |  |  | 30 | ms |
| Oscillator startup voltage | $\left\|\mathrm{V}_{\text {STT }}\right\|$ | $\mathrm{Tstt} \leq 30 \mathrm{~ms}$ | CF oscillator specifications <br> With a $1-\mathrm{MHz}$ CF element used <br> $\mathrm{Ccg}=\mathrm{Ccd}=100 \mathrm{pF}$ |  |  | 2.5 | V |
| Oscillator hold voltage | $\left\|\mathrm{V}_{\text {HOLD }}\right\|$ |  |  | 2.4 |  | 6.0 | V |
| Oscillator startup time | $\left\|T_{\text {STT }}\right\|$ | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ |  |  |  | 30 | ms |
| Oscillator startup voltage | $\left\|\mathrm{V}_{\text {STT }}\right\|$ | $\mathrm{Tstt} \leq 30 \mathrm{~ms}$ | CF oscillator specifications <br> With a $4-\mathrm{MHz}$ CF element used <br> $\mathrm{Ccg}=\mathrm{Ccd}=33 \mathrm{pF}$ |  |  | 2.8 | V |
| Oscillator hold voltage | $\left\|\mathrm{V}_{\text {HOLD }}\right\|$ |  |  | 2.7 |  | 6.0 | V |
| Oscillator startup time | $\left\|T_{\text {STT }}\right\|$ | $\mathrm{V}_{\mathrm{DD}}=2.8 \mathrm{~V}$ |  |  |  | 30 | ms |
| Oscillator correction capacitance | Cd | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{XTOUT}$（built in） |  |  | 20 |  | pF |
| Continued on next pag |  |  |  |  |  |  |  |

Continued from preceding page．

| Parameter | Symbol | Conditions and applicable pins |  | Ratings |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Input resistance | $\mathrm{R}_{\text {IN }} 1 \mathrm{~A}$ | $\mathrm{V}_{\mathrm{IN}}=0.2 \mathrm{~V}_{\mathrm{DD}}$ ，Low level hold transistor＊ | 30 | 120 | 500 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{~B}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ ，Pull－down resistor＊ | 10 | 50 | 200 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{C}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}_{\mathrm{DD}}$ ，High level hold transistor＊ | 30 | 120 | 500 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 1 \mathrm{D}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，Pull－up resistor＊ | 10 | 50 | 200 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{~A}$ | $\mathrm{V}_{\text {IN }}=0.2 \mathrm{~V}_{\mathrm{DD}}$ ，INT pin low level hold transistor | 30 | 120 | 500 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{~B}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，INT pin pull－down resistor | 100 | 500 | 2000 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 2 \mathrm{C}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}_{\mathrm{DD}}$ ，INT pin high level hold transistor | 30 | 120 | 500 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\mathrm{IN}} 2 \mathrm{D}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，INT pin pull－up resistor | 100 | 500 | 2000 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 3$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，RES pin pull－down resistor | 10 | 30 | 50 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 4$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ ，RES pin pull－up resistor | 10 | 30 | 50 | $\mathrm{k} \Omega$ |
|  | $\mathrm{R}_{\text {IN }} 5$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ ，TST pin pull－down resistor | 10 | 30 | 50 | $\mathrm{k} \Omega$ |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 1$ | $\mathrm{I}_{\mathrm{OH}}=-5.0 \mathrm{~mA}, \mathrm{~N} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 1$ | $\mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~N} 1$ to 4 |  |  | 0.5 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{2}$ | $\mathrm{I}_{\mathrm{OH}}=-1.0 \mathrm{~mA}, \mathrm{~K} 1$ to $4, \mathrm{P} 1$ to $4, \mathrm{M} 1$ to $4, \mathrm{SO} 1$ to 4 （With the K，P，M，and SO ports in output mode） | $V_{D D}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\mathrm{OL}} 2$ | $\mathrm{IOL}=2.0 \mathrm{~mA}, \mathrm{~K} 1$ to $4, \mathrm{P} 1$ to $4, \mathrm{M} 1$ to $4, \mathrm{SO} 1$ to 4 （With the K，P，M，and SO ports in output mode） |  |  | 0.5 | V |
| Output off leakage current | ｜OFF｜ | $\mathrm{V}_{\mathrm{OH}}=10.5 \mathrm{~V}$ ，N1 to 4 （Open specifications） |  |  | 1.0 | $\mu \mathrm{A}$ |
| Segment Port Output Impedances ［CMOS output port mode］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 3$ | $\mathrm{I}_{\text {OH }}=-500 \mu \mathrm{~A}$ ，Seg 1 to 23 | $V_{D D}-0.5$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }}{ }^{3}$ | $\mathrm{I}_{\mathrm{OL}}=500 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.5 | V |
| ［P－channel open－drain output port mode］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\text {OH }}=-500 \mu \mathrm{~A}$ ，Seg 1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.5$ |  |  | V |
| Output off leakage current | ｜ OFF ｜ | $\mathrm{V}_{\mathrm{OL}}=\mathrm{V}_{\mathrm{SS}}$ ，Seg 1 to 23 |  |  | 1.0 | $\mu \mathrm{A}$ |
| ［N－channel open－drain output port mode］ |  |  |  |  |  |  |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 3$ | l OL $=500 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.5 | V |
| Output off leakage current | ｜OFF｜ | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}$ ，Seg 1 to 23 |  |  | 1.0 | $\mu \mathrm{A}$ |
| ［Static drive］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 4$ | $\mathrm{I}_{\mathrm{OH}}=-40 \mu \mathrm{~A}$ ，Seg 1 to 23 | $V_{D D}-0.2$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 4$ | $\mathrm{I}_{\mathrm{OL}}=40 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.2 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 5$ | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}, \mathrm{COM} 1$ | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 5$ | $\mathrm{IOL}=400 \mu \mathrm{~A}, \mathrm{COM} 1$ |  |  | 0.2 | V |
| ［1／2 bias drive］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{4}$ | $\mathrm{I}_{\mathrm{OH}}=-40 \mu \mathrm{~A}$ ，Seg 1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  |  | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 4$ | $\mathrm{I}_{\text {OL }}=40 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.2 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{5}$ | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  |  | V |
| Output middle－level voltage | $\mathrm{V}_{\text {OM }}$ | $\mathrm{I}_{\text {OH }}=-400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\text {D } / 2-0.2 ~}^{\text {／}}$ |  | $\mathrm{V}_{\mathrm{DD}} / 2+0.2$ | V |
|  |  | $\mathrm{IOL}=400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}} / 2-0.2$ |  | $\mathrm{V}_{\mathrm{DD}} / 2+0.2$ | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 5$ | $\mathrm{IOL}=400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 |  |  | 0.2 | V |
| ［1／3 bias drive］ |  |  |  |  |  |  |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 4$ | $\mathrm{I}_{\mathrm{OH}}=-40 \mu \mathrm{~A}$ ，Seg1 to 23 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  |  | V |
| Output middle－level voltage | $\mathrm{V}_{\mathrm{OM} 1-1}$ | $\mathrm{I}_{\mathrm{OH}}=-40 \mu \mathrm{~A}$ ，Seg1 to 23 | $2 \mathrm{~V}_{\text {D } / 3}$－0．2 |  | $2 \mathrm{~V}_{\text {DD }} / 3+0.2$ | V |
|  | $\mathrm{V}_{\text {OM }}{ }^{1-2}$ | IOL $=40 \mu \mathrm{~A}$ ，Seg 1 to 23 | $2 \mathrm{~V}_{\text {DD }} / 3-0.2$ |  | $2 \mathrm{~V}_{\mathrm{DD}} / 3+0.2$ | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 4$ | $\mathrm{IOL}=40 \mu \mathrm{~A}$ ，Seg 1 to 23 |  |  | 0.2 | V |
| High－level output voltage | $\mathrm{V}_{\mathrm{OH}} 6$ | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  |  | V |
| Output middle－level voltage | $\mathrm{V}_{\text {OM }}{ }^{2-1}$ | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $2 \mathrm{~V}_{\text {DD }} / 3-0.2$ |  | $2 \mathrm{~V}_{\text {DO }} / 3+0.2$ | V |
|  | $\mathrm{V}_{\text {OM }}{ }^{2-2}$ | $\mathrm{I}_{\text {OL }}=400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 | $\mathrm{V}_{\mathrm{DD}} / 3-0.2$ |  | $\mathrm{V}_{\mathrm{DD}} / 3+0.2$ | V |
| Low－level output voltage | $\mathrm{V}_{\text {OL }} 6$ | $\mathrm{IOL}=400 \mu \mathrm{~A}, \mathrm{COM} 1$ to 4 |  |  | 0.2 | V |

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| Parameter | Symbol | Conditions and applicable pins |  | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| Supply leakage current | ILEK1 | $\mathrm{V}_{\mathrm{DD}}=6.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ |  |  | 0.2 | 1.0 | $\mu \mathrm{A}$ |
|  | ILEK2 | $\mathrm{V}_{\mathrm{DD}}=6.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  | 1.0 | 5.0 | $\mu \mathrm{A}$ |
| Input leakage current | I OFF | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}$ ，S1 to 4，K1 to 4，P1 to 4，M1 to 4，SO1 to 4，INT，RES <br> （With the K，P，M，and SO ports in input mode and with the open specifications selected for the INT and RES pins．） |  |  |  | 1.0 | $\mu \mathrm{A}$ |
|  |  |  |  | －1．0 |  |  | $\mu \mathrm{A}$ |
| Output voltage 2 | $V_{D D 1-2}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{C} 1=\mathrm{C} 2=0.1 \mu \mathrm{~F}, \mathrm{~V}_{\mathrm{DD}} 1=\mathrm{V}_{\mathrm{DD}} 2,1 / 2 \text { Bias, } \\ & \text { fopg }=32.768 \mathrm{kHz} \end{aligned}$ |  | 2.4 | 2.5 | 2.6 | V |
| Output voltage 3 | $\mathrm{V}_{\mathrm{DD} 1} 1-3$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{C} 1=\mathrm{C} 2=0.1 \mu \mathrm{~F}$ |  | 1.4 | 1.67 | 1.8 | V |
|  | $\mathrm{V}_{\mathrm{DD}}{ }^{2-3}$ | $1 / 3$ bias，fopg $=32.768 \mathrm{kHz}$ |  | 3.1 | 3.33 | 3.5 | V |
| Current drain 1 | ｜lid $11-1$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | Crystal oscillator specifications Crystal： 32 kHz （Cd and Rd built in） $\mathrm{Cg}=11 \mathrm{pF}, \mathrm{Cl}=31 \mathrm{k} \Omega$ Halt mode，LCD $=1 / 3$ bias |  | 45.0 | 60.0 | $\mu \mathrm{A}$ |
|  | $\\|_{\text {DD }} 11-2$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 65 | $\mu \mathrm{A}$ |
| Current drain 2 | ｜lod ${ }_{\text {D }}$ 2－1 | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | CF oscillator specifications CF： 455 kHz $\mathrm{Ccg}=\mathrm{Ccd}=220 \mathrm{pF}$ Halt mode，LCD $=1 / 3$ bias |  | 450 | 600 | $\mu \mathrm{A}$ |
|  | ｜${ }_{\text {DD }} \mid 2-2$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 650 | $\mu \mathrm{A}$ |
| Current drain 3 | $\\|_{\text {DD }} \mid 3-1$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | CF oscillator specifications CF： 4000 kHz$\mathrm{Ccg}=\mathrm{Ccd}=33 \mathrm{pF}$$\text { Halt mode, LCD }=1 / 3 \text { bias }$ |  | 500 | 700 | $\mu \mathrm{A}$ |
|  | $\\|_{\text {DD }} \mid 3-2$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 800 | $\mu \mathrm{A}$ |
| Current drain 4 | ｜lid $14-1$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ | $\begin{aligned} & \text { CF oscillator specifications } \\ & \text { CF: } 6000 \mathrm{kHz} \\ & \mathrm{Ccg}=. \mathrm{Ccd}=33 \mathrm{pF} \\ & \text { Halt mode, } \mathrm{LCD}=1 / 3 \text { bias } \end{aligned}$ |  | 800 | 1000 | $\mu \mathrm{A}$ |
|  | $\\|_{\text {DD }} \mid 4-2$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |  |  |  | 1150 | $\mu \mathrm{A}$ |
| Oscillator correction capacitance | Cd | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{XTOUT}$（built in） |  |  | 20 |  | pF |

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[^0]:    －Pad 20 must be connected to $\mathrm{V}_{\text {SS }}$ ．
    －Pads 34 and 35 must be left open．

[^1]:    Note＊：The state where the CF／RC and crystal oscillators are completely stopped，and all internal circuits completely stopped．

